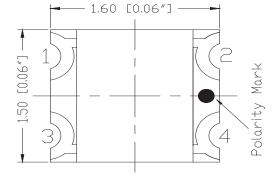
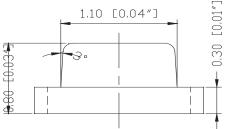


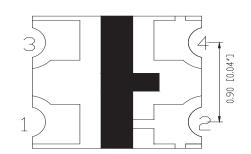
SPECIFICATION

CST66Y2GT2B2C

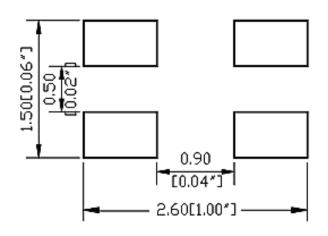
PACKAGE OUTLINES

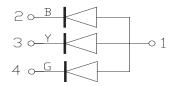






RECOMMENDED PAD LAYOUT





Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is \pm 0.25mm (0.01") unless otherwised noted.
- 3. Specifications are subject to change without notice.

Part Number	Chip Material	Color of Emission	Lens Type	Viewing Angle	
	InGaAlP	Yellow	Water Clear	140°	
CST66Y2GT2B2C	InGaN	True Green	Water Clear	140°	
	InGaN	Blue	Water Clear	140°	





ABSOLUTE MAXIMUM RATINGS

(TA=25°C)

		Max Rating			
Parameter	Symbol	Blue/ Green	Yellow	Unit	
Forward Current	lF	30	30	mA	
Reverse Voltage	VR	5 5		V	
Power Dissipation	Pd	111	75	mW	
Operating Temperature Range	Тор	-40~+80		°C	
Storage Temperature Range	Тѕтс	-40~+85		°C	
Peak Pulsing Current (tp \leq 10 μ S, duty cycle = 0.005)	lFP	125		mA	

OPTICAL-ELECTRICAL CHARACTERISTICS

(TA=25°C)

Daramatar	Symbol	Test Condition	Color	Value		l lesit	
Parameter				Min	Тур	Max	Unit
Luminous Intensity	lv	IF = 20mA	Yellow	80	120	-	mcd
			Green	250	440	-	
			Blue	63	100	-	
Forward Voltage	VF	IF = 20mA	Yellow	-	2.0	2.5	V
			Green	-	3.1	3.7	
			Blue	-	3.1	3.7	
Viewing Angle at 50% Iv	201/2	IF = 20mA	-	-	140	1	Deg
	λD	IF = 20mA	Yellow	585	590	595	nm
Dominant Wavelength			Green	520	525	530	
			Blue	465	470	475	

^{*}Tolerance of viewing angle: -10 / +5 deg.



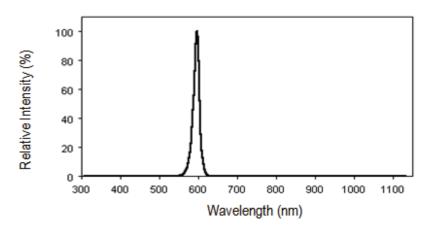
^{*}Tolerance of forward voltage is -/+ 0.05V

^{*}Tolerance of luminous intensity -/+ 1nm

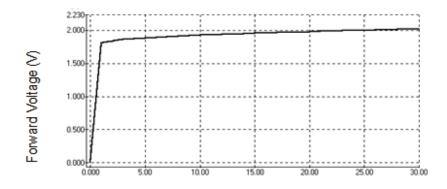


TYPICAL ELECTRO-OPTICAL CHARACTERISTIC CURVES (YELLOW)

Relative Intensity vs. Wavelength

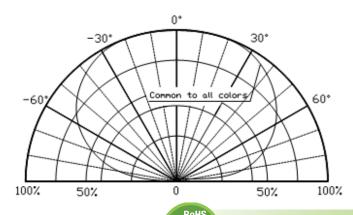


Forward Current vs. Forward Voltage



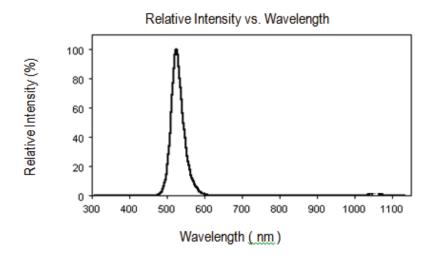
Forward Current (mA)

Directive Characteristics

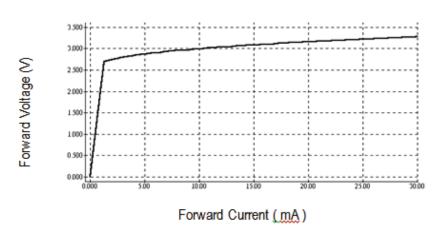




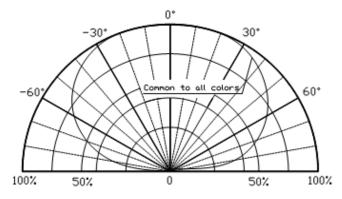
TYPICAL ELECTRO-OPTICAL CHARACTERISTIC CURVES (GREEN)



Forward Current vs. Forward Voltage



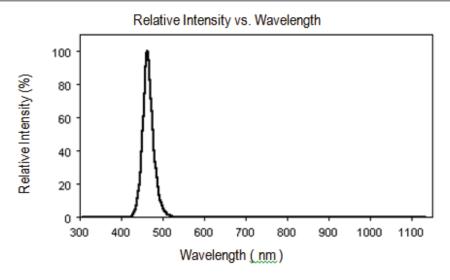
Directive Characteristics



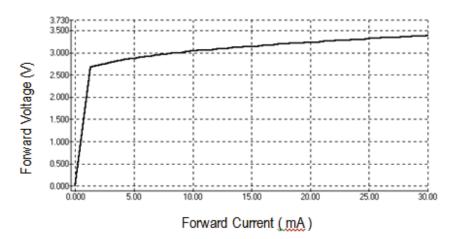




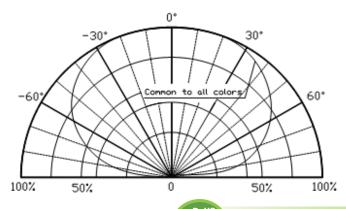
TYPICAL ELECTRO-OPTICAL CHARACTERISTIC CURVES (BLUE)



Forward Current vs. Forward Voltage



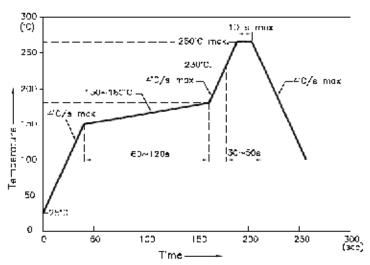
Directive Characteristics





SOLDERING CONDITIONS

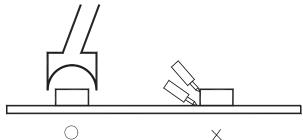
REFLOW PROFILE



- 1. We recommend the reflow temperature 245°C (±5°C).the maximum soldering temperature should be limited to 260°C.
- 2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
- 3. Number of reflow process shall be 2 times or less.
 - Soldering iron
 - Basic spec is ≤ 5sec when 260°C. If temperature is higher, time should be shorter
 - (+10°C → -1sec). Power dissipation of iron should be smaller than 20W, and temperatures should be controllable. Surface temperature of the device should be under 230°C.

Rework

- 1. Customer must finish rework within 5 sec under 260°C.
- 2. The head of iron cannot touch copper foil.
- 3. Twin-head type is preferred.



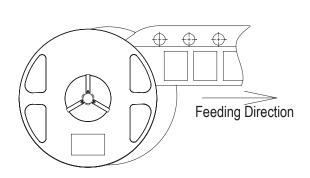




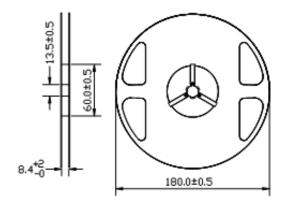
REEL PACKAGING

PACKAGING SPECIFICATION

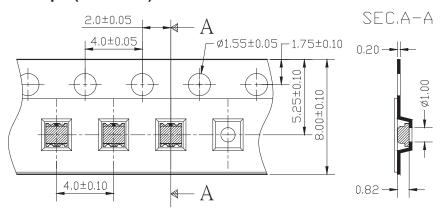
• Feeding Direction



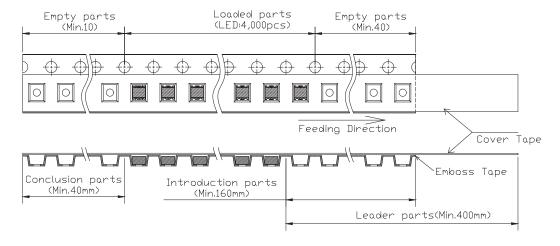
Dimensions of Reel (Unit: mm)



• Dimensions of Tape (Unit: mm)



Arrangement of Tape



Notes:

- 1. Empty component pockets are sealed with top cover tape;
- 2. The maximum number of missing lamps is two;
- 3. 4,000pcs/Reel

